

1350V 5A N-Channel Enhancement Mode Power MOSFET

Description

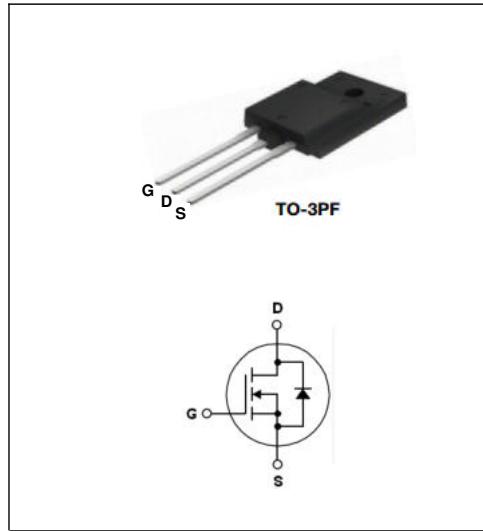
The AKT5N135G is an N-Channel enhancement mode power MOSFET, it has low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for switched mode power supplies, active power factor correction and electronic lamp ballasts.

Features

- Low on-Resistance: $R_{DS(on)}=4.0\Omega(\text{typ.})$
- Special Process Technology for high ESD Capability
- 100% Avalanche Test
- Good Stability and Uniformity with High E_{AS}

Applications

- Switched Mode Power Supplies
- Active Power Factor Correction, Electronic Ballasts



Absolute Maximum Ratings @ $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter		Ratings	Unit
V_{DSS}	Drain to Source Voltage		1400	V
V_{GSS}	Gate to Source Voltage		± 30	V
I_D	Drain Current	$T_C=25^\circ\text{C}$	5	A
		$T_C=100^\circ\text{C}$	3	A
I_{DM}	Pulsed Drain Current	(Note1)	15	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	74	W
	Derate above 25°C		0.59	W/ $^\circ\text{C}$
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	500	mJ
T_J	Operating Junction Temperature Range		-55~+150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55~+150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	1.69	$^\circ\text{C}/\text{W}$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=1\text{mA}$	1400	-	-	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	3.0	-	5.0	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=2.5\text{A}$	-	4.0	4.6	Ω
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0\text{V}$	-	-	10	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0\text{V}$	-	-	± 100	nA

D-S Diode Characteristics and Maximum Rating @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Maximum Drain to Source Diode Forward Current		-	-	5.0	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=5\text{A}$	-	0.84	0.9	V
T_{rr}	Reverse Recovery Time	$V_{GS}=0\text{V}, I_S=5\text{A},$ $dI/dt=-100\text{A}/\mu\text{s}$	-	525	-	ns
Q_{rr}	Reverse Recovery Charge		-	3182	-	nC

Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=5\text{A},$ $V_{DD}=750\text{V},$ $R_G=25\Omega$	-	33	-	ns
t_r	Rise Time		-	27	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	40	-	ns
t_f	Fall Time		-	42	-	ns
C_{ies}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V},$ $f=1.0\text{MHz}$	-	1915	-	pF
C_{oes}	Output Capacitance		-	118	-	pF
C_{rss}	Reverse Transfer Capacitance		-	4.8	-	pF
Q_g	Total Gate Charge	$I_D=5\text{A},$ $V_{DD}=1200\text{V}$	-	40	-	nC
Q_{gs}	Gate to Source Charge		-	11	-	nC
Q_{gd}	Gate to Drain Charge		-	14	-	nC

Note:

- Repetitive rating: pulse-width limited by maximum junction temperature
- $V_{DD}=100\text{V}, L=10\text{mH}, R_G=25\Omega, V_G=10\text{V}$, stating $T_J=25\text{ }^\circ\text{C}$
- Essentially independent of operating temperature typical characteristics

Typical Performance Characteristics

Fig. 1. Typical on-Region Characteristics

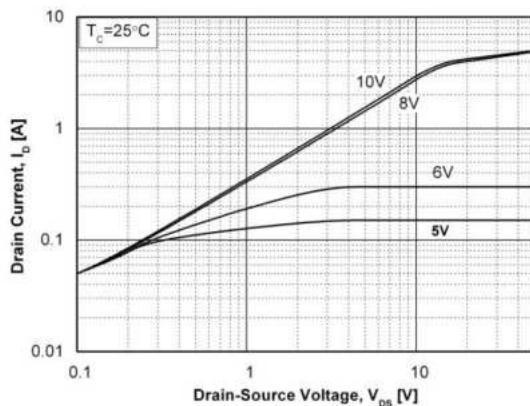


Fig. 3. Static on-Resistance vs. I_D

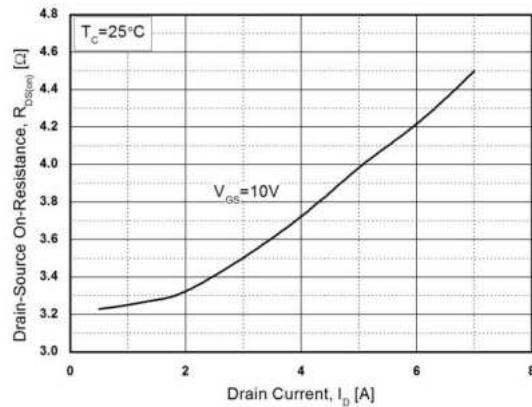


Fig. 5. Capacitance Characteristics

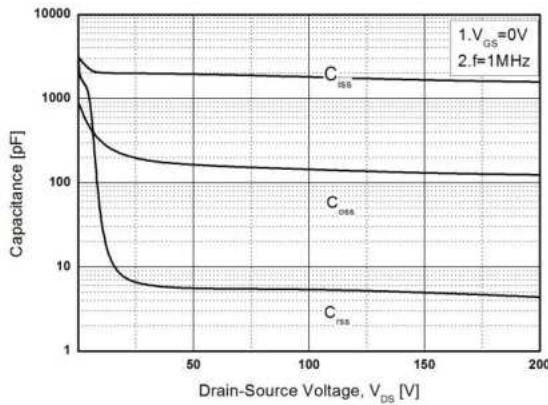


Fig. 2. Typical Transfer Characteristics

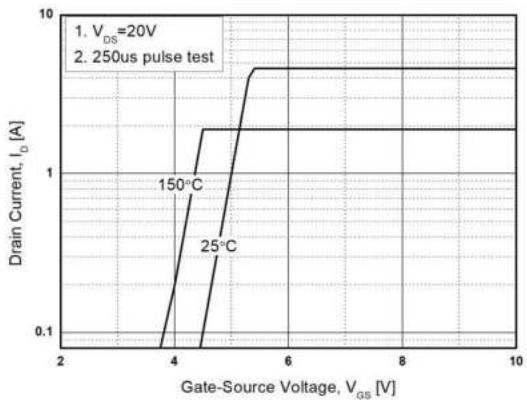


Fig. 4. Body Diode Forward Voltage vs. I_{DR}

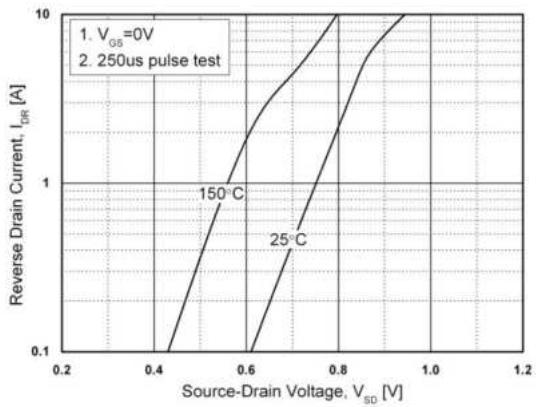
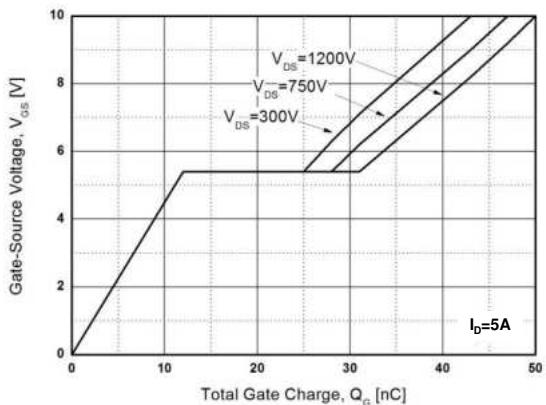


Fig. 6. Gate Charge Characteristics



Typical Performance Characteristics

Fig. 7. Breakdown Voltage vs. Temperature

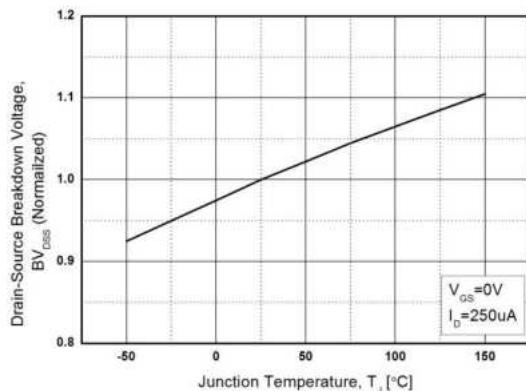


Fig. 8. Static on-Resistance vs. Temperature

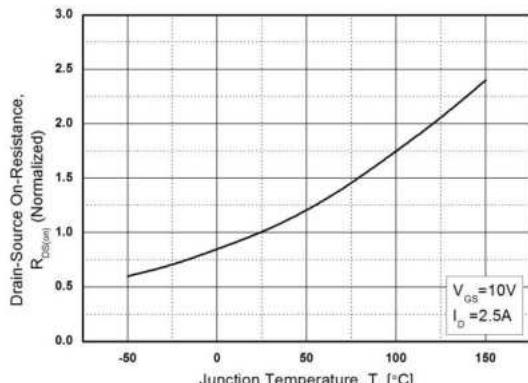


Fig. 9. Maximum Safe Operating Area

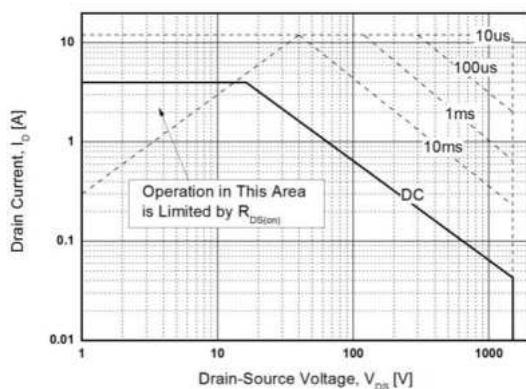


Fig. 10. Maximum Drain Current vs. Temperature

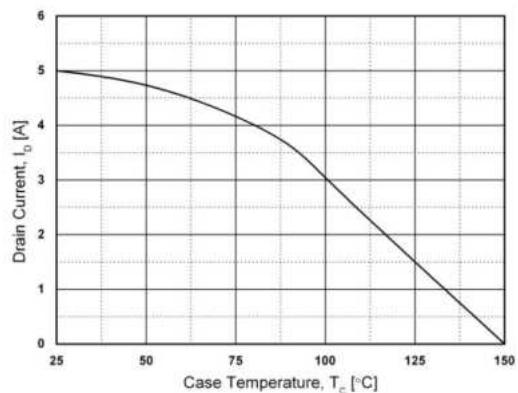
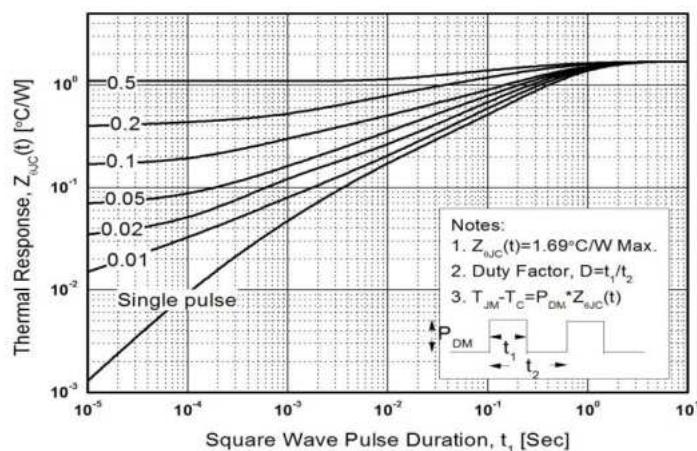


Fig. 11. Transient Thermal Response Curve



Package Dimensions

TO-3PF

(Dimensions in Millimeters)

